

ABSTRACT

An object of the present invention is to provide a conductive composition having favorable coating properties and being less likely to generate foreign matter upon forming a coating film; a method for producing the same; a water soluble composition which is used in the conductive composition; and a method for producing the same. A water soluble composition including a water soluble polymer, in which the water soluble composition satisfies the following Conditions (A1) and (A2). In addition, a method for producing the water soluble composition, the method including a reprecipitation step of mixing a good solvent solution including the water soluble composition and a good solvent for the water soluble composition with a poor solvent for the water soluble composition, the poor solvent including an ether.

(A1) The water soluble polymer includes a nitrogen-containing functional group.

(A2) A 1.0% by mass aqueous solution of the water soluble composition has a surface tension at 25°C of 34.0 to 50.0.

(No Figure)